

# MOS FIELD EFFECT TRANSISTOR $\mu$ PA1721

### SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

#### DESCRIPTION

The  $\mu$ PA1721 is N-Channel MOS Field Effect Transistor designed for DC/DC converters and power management applications of notebook computers.

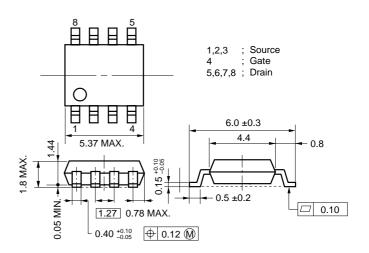
#### FEATURES

- Low on-resistance  $R_{DS(on)1} = 10.5 \text{ m}\Omega \text{ MAX.}$  (Vgs = 10 V, ID = 5.0 A)  $R_{DS(on)2} = 14.0 \text{ m}\Omega \text{ MAX.}$  (Vgs = 4.5 V, ID = 5.0 A)  $R_{DS(on)3} = 17.0 \text{ m}\Omega \text{ MAX.}$  (Vgs = 4.0 V, ID = 5.0 A)
- Low Ciss: Ciss = 2200 pF TYP.
- Built-in G-S protection diode
- Small and surface mount package (Power SOP8)

#### **ORDERING INFORMATION**

| PART NUMBER | PACKAGE    |
|-------------|------------|
| μΡΑ1721G    | Power SOP8 |

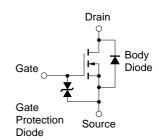
#### PACKAGE DRAWING (Unit : mm)



#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C, All terminals are connected.)

#### EQUIVALENT CIRCUIT

| Drain to Source Voltage (Vgs = 0 V)                   | VDSS     | 30          | V  |  |
|---|----------|-------------|----|--|
| Gate to Source Voltage (VDS = 0 V)                    | Vgss     | ±20         | V  |  |
| Drain Current (DC)                                    | D(DC)    | ±10         | А  |  |
| Drain Current (pulse) <sup>Note1</sup>                | D(pulse) | ±40         | А  |  |
| Total Power Dissipation $(T_A = 25^{\circ}C)^{Note2}$ | Р⊤       | 2.0         | W  |  |
| Channel Temperature                                   | Tch      | 150         | °C |  |
| Storage Temperature                                   | Tstg     | –55 to +150 | °C |  |



**Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1 %

2. Mounted on ceramic substrate of 1200 mm<sup>2</sup> x 2.2 mm

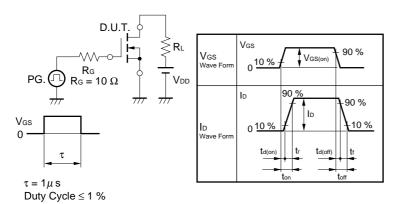
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**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

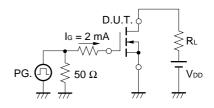
| CHARACTERISTICS                     | SYMBOL          | TEST CONDITIONS   | MIN. | TYP. | MAX. | UNIT |
|-------------------------------------|-----------------|---|------|------|------|------|
| Drain to Source On-state Resistance | RDS(on)1        | Vgs = 10 V, Id = 5.0 A                                    |      | 8.0  | 10.5 | mΩ   |
|                                     | RDS(on)2        | Vgs = 4.5 V, Id = 5.0 A                                   |      | 10.0 | 14.0 | mΩ   |
|                                     | RDS(on)3        | Vgs = 4.0 V, Id = 5.0 A                                   |      | 12.0 | 17.0 | mΩ   |
| Gate to Source Cut-off Voltage      | VGS(off)        | Vds = 10 V, Id = 1 mA                                     | 1.5  | 2.0  | 2.5  | V    |
| Forward Transfer Admittance         | y <sub>fs</sub> | Vds = 10 V, Id = 5.0 A                                    | 7.0  | 14.0 |      | S    |
| Drain Leakage Current               | IDSS            | $V_{DS} = 30 V, V_{GS} = 0 V$                             |      |      | 10   | μA   |
| Gate to Source Leakage Current      | lgss            | $V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$ |      |      | ±10  | μA   |
| Input Capacitance                   | Ciss            | VDS = 10 V  |      | 2200 |      | pF   |
| Output Capacitance                  | Coss            | Vgs = 0 V   |      | 710  |      | pF   |
| Reverse Transfer Capacitance        | Crss            | f = 1 MHz   |      | 270  |      | pF   |
| Turn-on Delay Time                  | td(on)          | ID = 5.0 A  |      | 30   |      | ns   |
| Rise Time                           | tr              | $V_{GS(on)} = 10 V$                                       |      | 90   |      | ns   |
| Turn-off Delay Time                 | $t_{d(off)}$    | Vdd = 15 V  |      | 90   |      | ns   |
| Fall Time                           | tr              | R <sub>G</sub> = 10 Ω                                     |      | 50   |      | ns   |
| Total Gate Charge                   | Q <sub>G</sub>  | ID = 10 A   |      | 39   |      | nC   |
| Gate to Source Charge               | QGS             | Vdd = 24 V  |      | 6.3  |      | nC   |
| Gate to Drain Charge                | Qgd             | V <sub>GS</sub> = 10 V                                    |      | 10.0 |      | nC   |
| Body Diode Forward Voltage          | VF(S-D)         | IF = 10 A, VGs = 0 V                                      |      | 0.8  |      | V    |
| Reverse Recovery Time               | trr             | IF = 10 A, VGS = 0 V                                      |      | 40   |      | ns   |
| Reverse Recovery Charge             | Qrr             | di/dt = 100 A/ μs   |      | 50   |      | nC   |

#### ELECTRICAL CHARACTERISTICS (TA = 25 °C, All terminals are connected.)

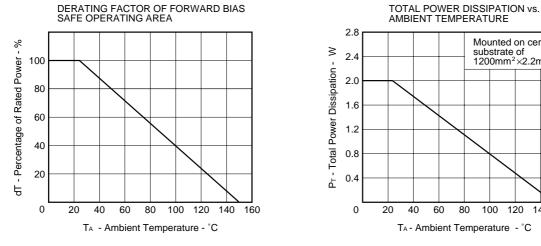
#### TEST CIRCUIT 1 SWITCHING TIME

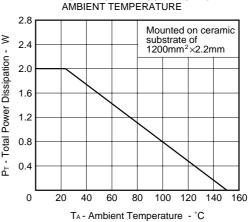


#### TEST CIRCUIT 2 GATE CHARGE

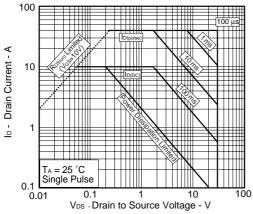


TYPICAL CHARACTERISTICS (TA = 25 °C) \*

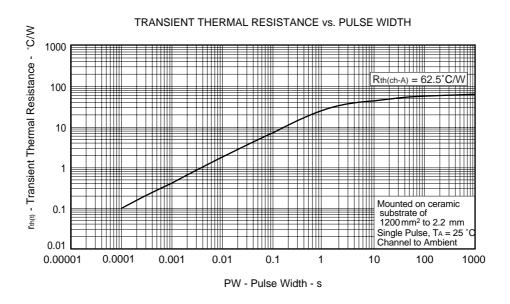






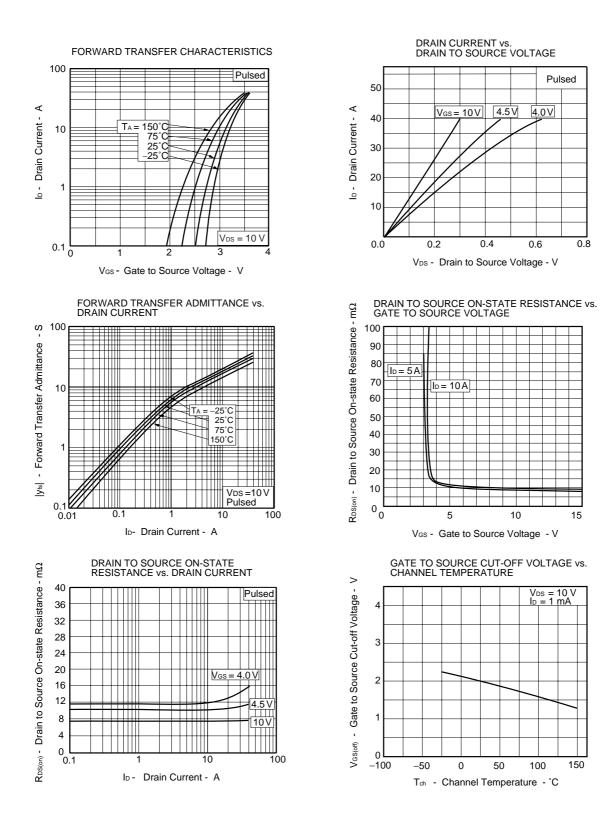


Note Mounted on ceramic substrate of  $1200 \text{ mm}^2 \times 2.2 \text{ mm}$ 



Data Sheet G13889EJ1V0DS00

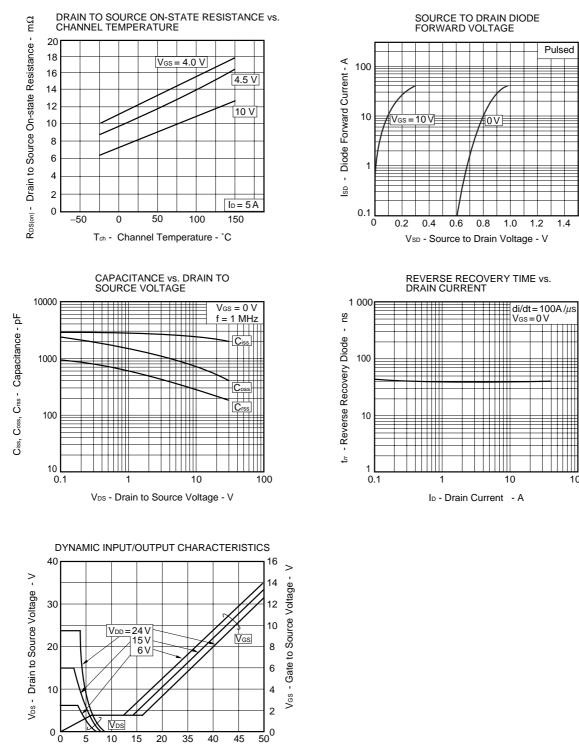




μ**PA1721** 

1.4

100



15 20 35 40 10 QG - Gate Charge - nC

NEC

Data Sheet G13889EJ1V0DS00

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## NEC

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